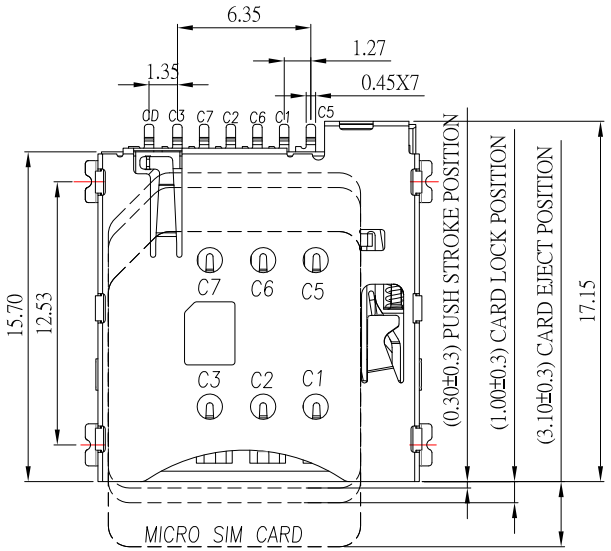
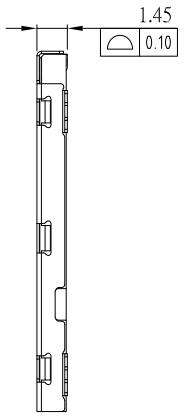
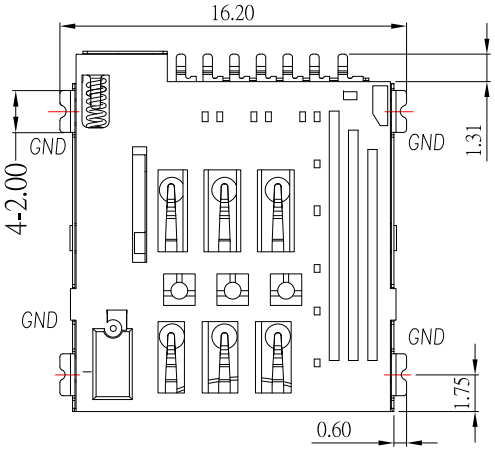
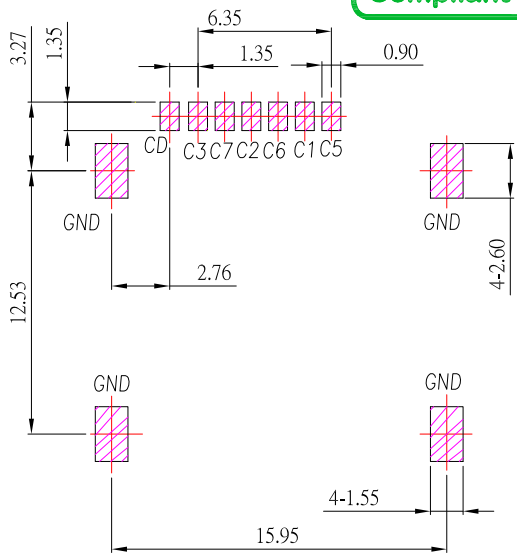
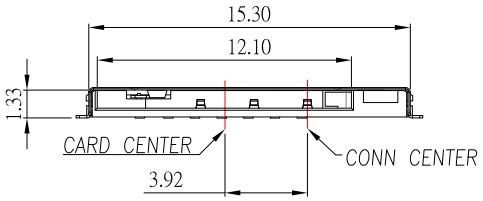


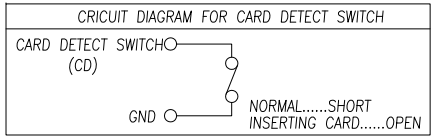


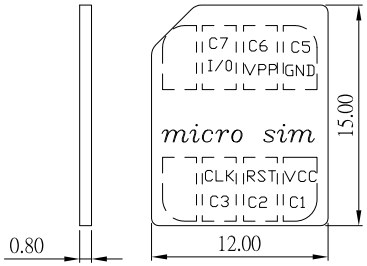




PCB LAYOYT







MICRO SIM CARD

SIM pin Assignment	
PIN#	Name
C1	VCC
C2	RST
C3	CLK
C5	GND
C6	VPP
C7	I/O

Material:

1.Housing: LCP

2.Contact: Copper Alloy

3.Shell: SUS

Finish:

1.Contact: Plated Gold in Mating Area ;
Gold Plated on Solder Balls ;
Nickel under plated overall

2.Shell: Nickel under Plated surface laye

ITEM NO.	DESCRIPTION	DRAWN	DATE
3	更新樣式	Jack	102820
2	更新尺寸	Jack	101518
1	更新樣式	Jack	101218

CONTACT 建倚科技股份有限公司
CONTACT TECHNOLOGY CORP.

TOLERANCE UNLESS OTHERWISE STATED : Up to 5 ±0.2; Above 5 ~ 15 ±0.3; Above 15 ~ 30 ±0.4; Above 30 ~ 50 ±0.5; Angle ±0.3°

3RD. ANGEL'S | UNITS MM

DRAWN BY: Jack Lu	DATE 10/28/20	MAT'L	
CHECKED BY: Jacky Chen	DATE 10/28/20	FINISH	
APPROVED BY: Tony Kao	DATE 10/28/20	SCALE 1 : 1	SHEET NO. 1 of 1

TITLE	CONNECTOR		
MODLE	MICRO SIM CARD PUSH PUSH 7PIN 1.45H 帶CD PIN(防呆型)		
DWG NO.	MSIM-S3071-A1-S304	SIZE	A4
PART NO.	MSIM-S3071-A1-S304	VER	R3